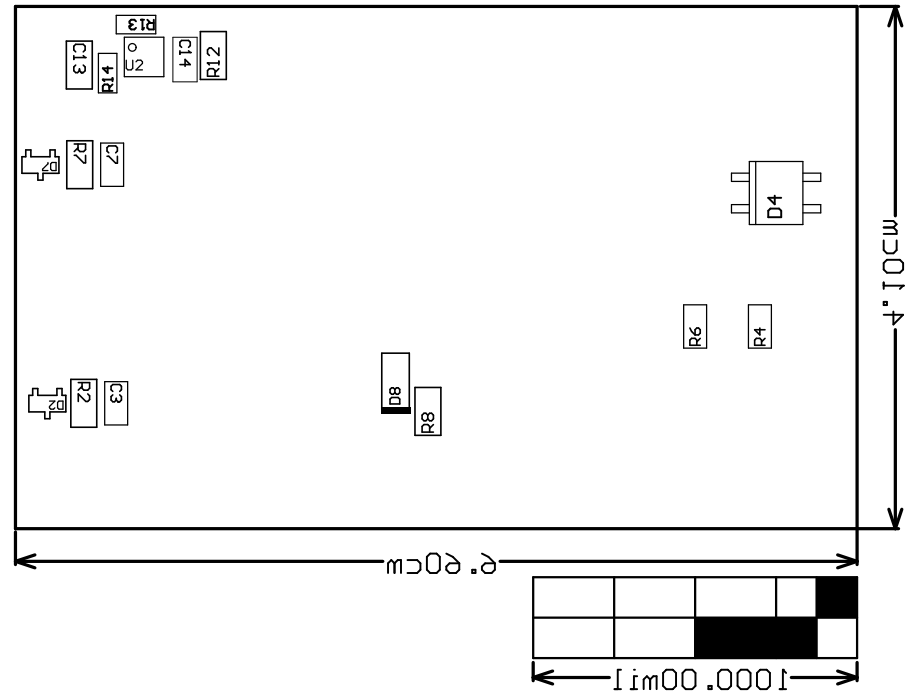


PCB VIEWED FROM TOP SIDE	BOARD #: PMP30198	REV:	SUN REV: Not In VersionControl
M2 Board Dimensions	TID #: N/A		
PLOT NAME = Assembly Top	GENERATED : 2/3/2017	9:21:18 AM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP30198	REV:	SUN REV: Not In VersionControl
	TID #: N/A	MS Board Dimensions	
PLOT NAME = Assembly Bottom	GENERATED : 2/3/2017	9:21:19 AM	TEXAS INSTRUMENTS

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